

LMV331,LMV339,LMV393

*LMV331 Single / LMV393 Dual / LMV339 Quad General Purpose, Low Voltage,
Tiny Pack Comparators*



Literature Number: SNOS018F

LMV331 Single / LMV393 Dual / LMV339 Quad General Purpose, Low Voltage, Tiny Pack Comparators

General Description

The LMV393 and LMV339 are low voltage (2.7-5V) versions of the dual and quad comparators, LM393/339, which are specified at 5-30V. The LMV331 is the single version, which is available in space saving 5-pin SC70 and 5-pin SOT23 packages. The 5-pin SC70 is approximately half the size of the 5-pin SOT23.

The LMV393 is available in 8-pin SOIC and MSOP. The LMV339 is available in 14-pin SOIC and TSSOP.

The LMV331/393/339 is the most cost-effective solution where space, low voltage, low power and price are the primary specification in circuit design for portable consumer products. They offer specifications that meet or exceed the familiar LM393/339 at a fraction of the supply current.

The chips are built with National's advanced Submicron Silicon-Gate BiCMOS process. The LMV331/393/339 have bipolar input and output stages for improved noise performance.

Features

(For 5V supply, typical unless otherwise noted)

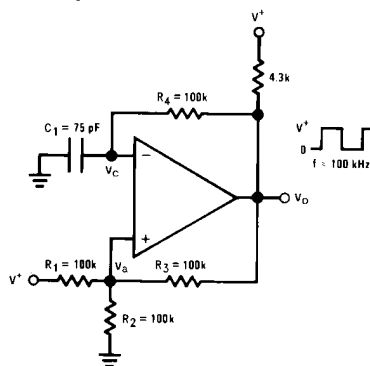
- Guaranteed 2.7V and 5V performance
- Industrial temperature range -40°C to $+85^{\circ}\text{C}$
- Low supply current 60 $\mu\text{A}/\text{Channel}$
- Input common mode voltage range includes ground
- Low output saturation voltage 200 mV
- Propagation delay 200 ns
- Space saving 5-pin SC70 and 5-Pin SOT23 packages

Applications

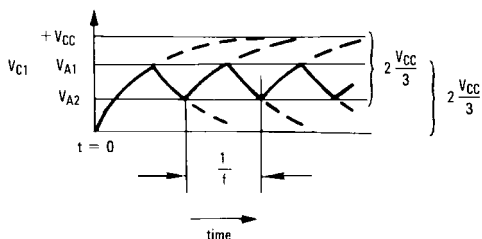
- Mobile communications
- Notebooks and PDA's
- Battery powered electronics
- General purpose portable device
- General purpose low voltage applications

Typical Applications

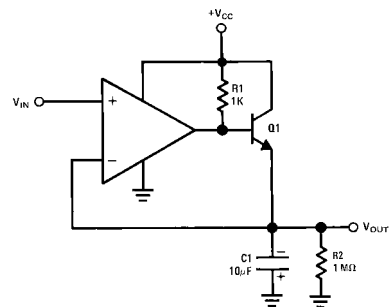
Squarewave Oscillator



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Positive Peak Detector

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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

ESD Tolerance (Note 2)

Human Body Model

LMV331/393/339 800V

Machine Model

LMV331/339/393 120V

Differential Input Voltage $\pm$ Supply Voltage

Voltage on any pin 5.5V

(referred to V⁻ pin)

Soldering Information

Infrared or Convection (20 sec) 235°C

Storage Temp. Range -65°C to +150°C

Junction Temperature (Note 3) 150°C

Operating Ratings (Note 1)

Supply Voltage 2.7V to 5.0V

Temperature Range (Note 3)
LMV393, LMV339, LMV331 -40°C to +85°CThermal Resistance (θ_{JA})

5-Pin SC70 478°C/W

5-Pin SOT23 265°C/W

8-Pin SOIC 190°C/W

8-Pin MSOP 235°C/W

14-Pin SOIC 145°C/W

14-Pin TSSOP 155°C/W

2.7V DC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for $T_J = 25^\circ\text{C}$, $V^+ = 2.7\text{V}$, $V^- = 0\text{V}$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 5)	Typ (Note 4)	Max (Note 5)	Units
V_{OS}	Input Offset Voltage			1.7	7	mV
TCV_{OS}	Input Offset Voltage Average Drift			5		$\mu\text{V}/^\circ\text{C}$
I_B	Input Bias Current			10	250 400	nA
I_{OS}	Input Offset Current			5	50 150	nA
V_{CM}	Input Voltage Range			-0.1		V
				2.0		V
V_{SAT}	Saturation Voltage	$I_{SINK} \leq 1\text{ mA}$		120		mV
I_O	Output Sink Current	$V_O \leq 1.5\text{V}$	5	23		mA
I_S	Supply Current	LMV331		40	100	μA
		LMV393		70	140	μA
		Both Comparators				
		LMV339		140	200	μA
		All four Comparators				
	Output Leakage Current			.003	1	μA

2.7V AC Electrical Characteristics

$T_J = 25^\circ\text{C}$, $V^+ = 2.7\text{V}$, $R_L = 5.1\text{ k}\Omega$, $V^- = 0\text{V}$.

Symbol	Parameter	Conditions	Min (Note 5)	Typ (Note 4)	Max (Note 5)	Units
t_{PHL}	Propagation Delay (High to Low)	Input Overdrive = 10 mV		1000		ns
		Input Overdrive = 100 mV		350		ns
t_{PLH}	Propagation Delay (Low to High)	Input Overdrive = 10 mV		500		ns
		Input Overdrive = 100 mV		400		ns

5V DC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for $T_J = 25^\circ\text{C}$, $V^+ = 5\text{V}$, $V^- = 0\text{V}$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 5)	Typ (Note 4)	max (Note 5)	Units
V_{OS}	Input Offset Voltage			1.7	7 9	mV
TCV_{OS}	Input Offset Voltage Average Drift			5		$\mu\text{V}/^\circ\text{C}$
I_B	Input Bias Current			25	250 400	nA
I_{OS}	Input Offset Current			2	50 150	nA
V_{CM}	Input Voltage Range			-0.1		V
				4.2		V
A_V	Voltage Gain		20	50		V/mV
V_{sat}	Saturation Voltage	$I_{SINK} \leq 4\text{ mA}$		200	400 700	mV
I_O	Output Sink Current	$V_O \leq 1.5\text{V}$		84	10	mA
I_S	Supply Current	LMV331		60	120 150	μA
		LMV393 Both Comparators		100	200 250	μA
		LMV339 All four Comparators		170	300 350	μA
	Output Leakage Current			.003	1	μA

5V AC Electrical Characteristics

$T_J = 25^\circ\text{C}$, $V^+ = 5\text{V}$, $R_L = 5.1\text{ k}\Omega$, $V^- = 0\text{V}$.

Symbol	Parameter	Conditions	Min (Note 5)	Typ (Note 4)	Max (Note 5)	Units
t_{PHL}	Propagation Delay (High to Low)	Input Overdrive = 10 mV		600		ns
		Input Overdrive = 100 mV		200		ns
t_{PLH}	Propagation Delay (Low to High)	Input Overdrive = 10 mV		450		ns
		Input Overdrive = 100 mV		300		ns

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical characteristics.

Note 2: Human Body Model, applicable std. MIL-STD-883, Method 3015.7. Machine Model, applicable std. JESD22-A115-A (ESD MM std. of JEDEC). Field-Induced Charge-Device Model, applicable std. JESD22-C101-C (ESD FICDM std. of JEDEC).

Note 3: The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA} . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A)/\theta_{JA}$. All numbers apply for packages soldered directly onto a PC board.

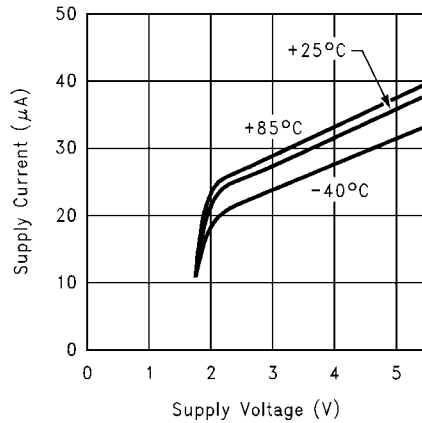
Note 4: Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not guaranteed on shipped production material.

Note 5: All limits are guaranteed by testing or statistical analysis.

Typical Performance Characteristics

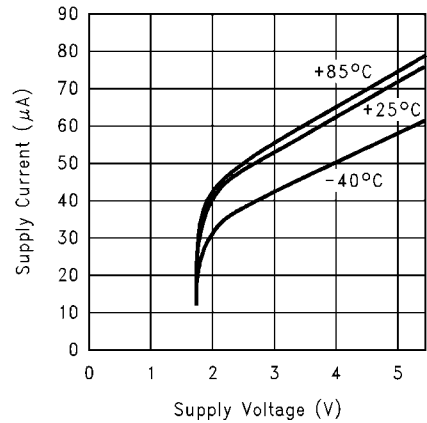
Unless otherwise specified, $V_S = +5V$, single supply, $T_A = 25^\circ C$

Supply Current vs. Supply Voltage Output High (LMV331)



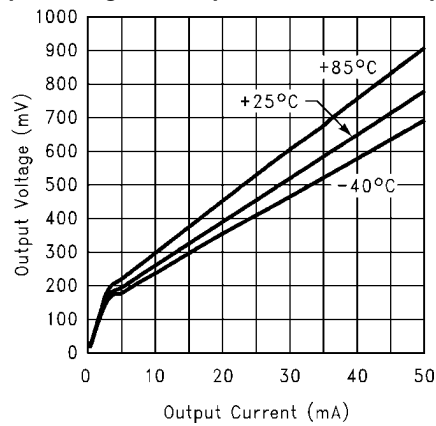
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Supply Current vs. Supply Voltage Output Low (LMV331)



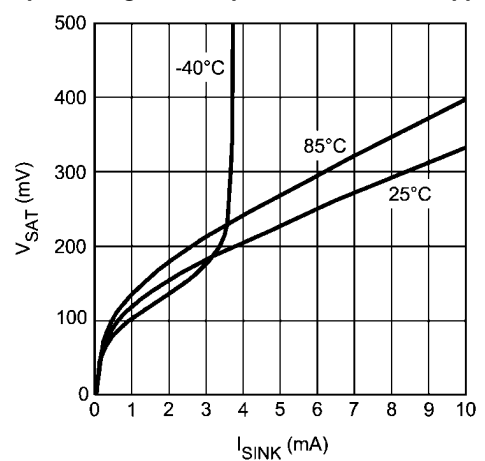
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Output Voltage vs. Output Current at 5V Supply



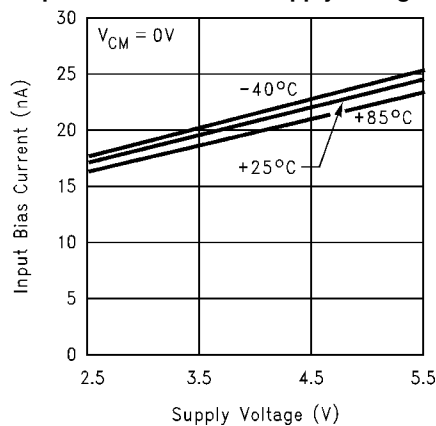
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Output Voltage vs. Output Current at 2.7 Supply



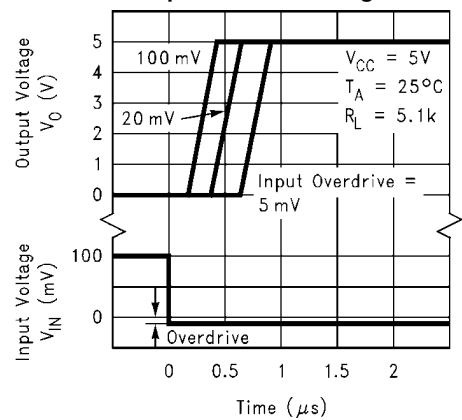
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Input Bias Current vs. Supply Voltage



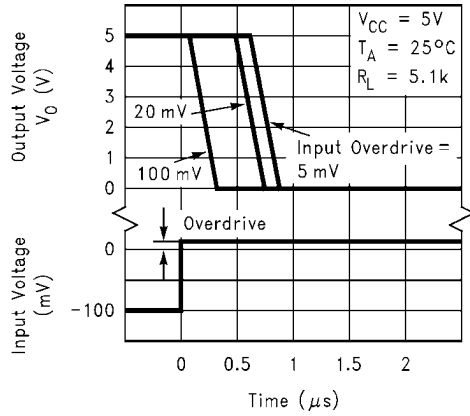
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Response Time vs. Input Overdrives Negative Transition



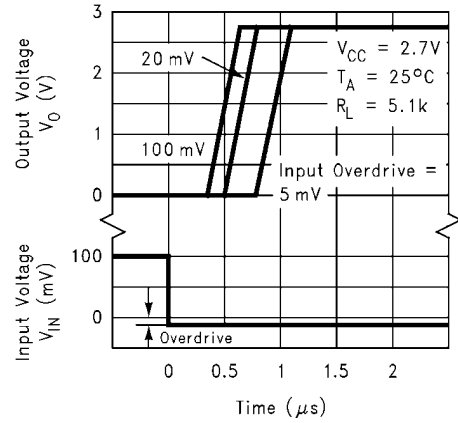
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Response Time for Input Overdrive Positive Transition



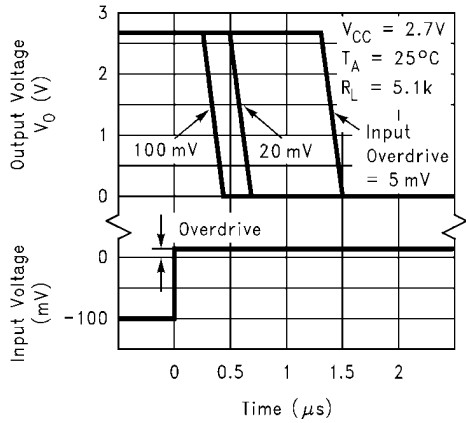
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Response Time vs. Input Overdrives Negative Transition



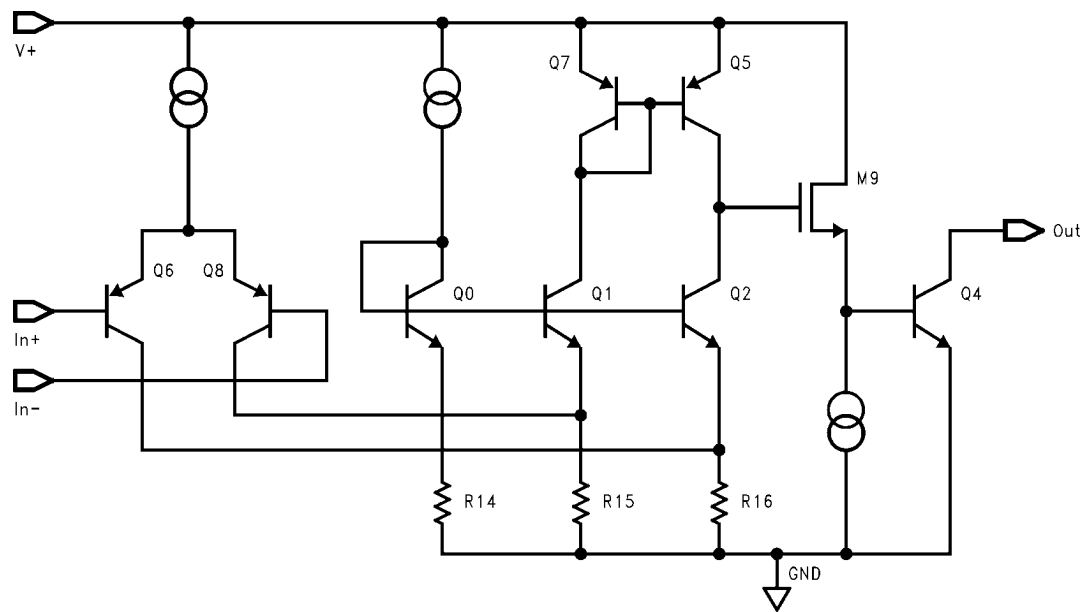
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Response Time for Input Overdrive Positive Transition



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Simplified Schematic



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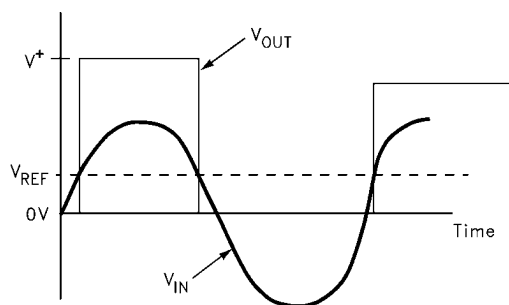
Application Circuits

BASIC COMPARATOR

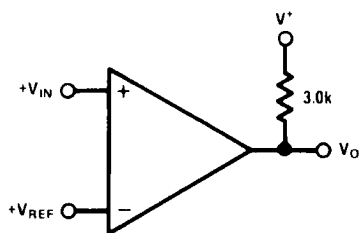
A basic comparator circuit is used for converting analog signals to a digital output. The LMV331/393/339 have an open-collector output stage, which requires a pull-up resistor to a positive supply voltage for the output to switch properly. When the internal output transistor is off, the output voltage will be pulled up to the external positive voltage.

The output pull-up resistor should be chosen high enough so as to avoid excessive power dissipation yet low enough to supply enough drive to switch whatever load circuitry is used on the comparator output. On the LMV331/393/339 the pull-up resistor should range between 1k to 10kΩ.

The comparator compares the input voltage (V_{IN}) at the non-inverting pin to the reference voltage (V_{REF}) at the inverting pin. If V_{IN} is less than V_{REF} , the output voltage (V_O) is at the saturation voltage. On the other hand, if V_{IN} is greater than V_{REF} , the output voltage (V_O) is at V_{CC} .



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FIGURE 1. Basic Comparator

COMPARATOR WITH HYSTERESIS

The basic comparator configuration may oscillate or produce a noisy output if the applied differential input voltage is near the comparator's offset voltage. This usually happens when the input signal is moving very slowly across the comparator's switching threshold. This problem can be prevented by the addition of hysteresis or positive feedback.

INVERTING COMPARATOR WITH HYSTERESIS

The inverting comparator with hysteresis requires a three resistor network that are referenced to the supply voltage V_{CC} of the comparator. When V_{in} at the inverting input is less than V_{a1} , the voltage at the non-inverting node of the comparator ($V_{in} < V_{a1}$), the output voltage is high (for simplicity assume V_O switches as high as V_{CC}). The three network resistors can be represented as R_1/R_3 in series with R_2 . The lower input trip voltage V_{a1} is defined as

$$V_{a1} = \frac{V_{CC} R_2}{(R_1 \parallel R_3) + R_2}$$

When V_{in} is greater than V_{a1} ($V_{in} > V_{a1}$), the output voltage is low very close to ground. In this case the three network resistors can be presented as R_2/R_3 in series with R_1 . The upper trip voltage V_{a2} is defined as

$$V_{a2} = \frac{V_{CC} (R_2 \parallel R_3)}{R_1 + (R_2 \parallel R_3)}$$

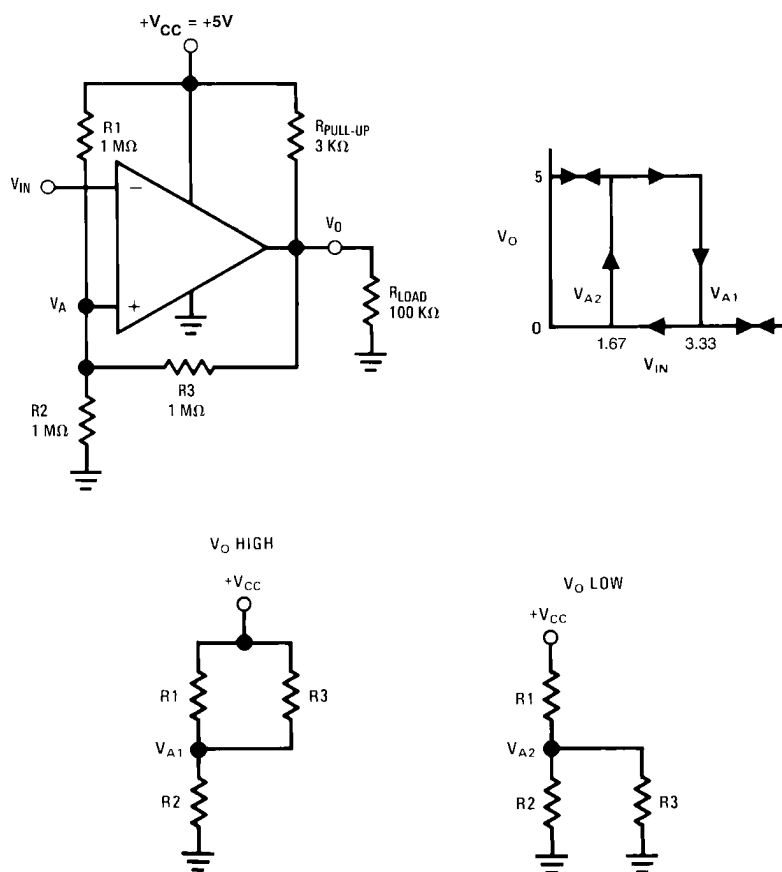
The total hysteresis provided by the network is defined as

$$\Delta V_a = V_{a1} - V_{a2}$$

To assure that the comparator will always switch fully to V_{CC} and not be pulled down by the load the resistors values should be chosen as follow:

$$R_{PULL-UP} \ll R_{LOAD}$$

$$\text{and } R_1 > R_{PULL-UP}$$



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FIGURE 2. Inverting Comparator with Hysteresis

NON-INVERTING COMPARATOR WITH HYSTERESIS

Non inverting comparator with hysteresis requires a two resistor network, and a voltage reference (V_{ref}) at the inverting input. When V_{in} is low, the output is also low. For the output to switch from low to high, V_{in} must rise up to V_{in1} where V_{in1} is calculated by

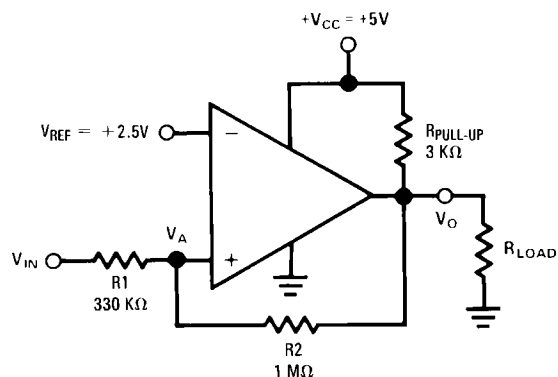
$$V_{in1} = \frac{V_{ref} (R_1 + R_2)}{R_2}$$

When V_{in} is high, the output is also high, to make the comparator switch back to its low state, V_{in} must equal V_{ref} before V_A will again equal V_{ref} . V_{in} can be calculated by:

$$V_{in2} = \frac{V_{ref} (R_1 + R_2) - V_{CC} R_1}{R_2}$$

The hysteresis of this circuit is the difference between V_{in1} and V_{in2} .

$$\Delta V_{in} = V_{CC} R_1 / R_2$$



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FIGURE 3.

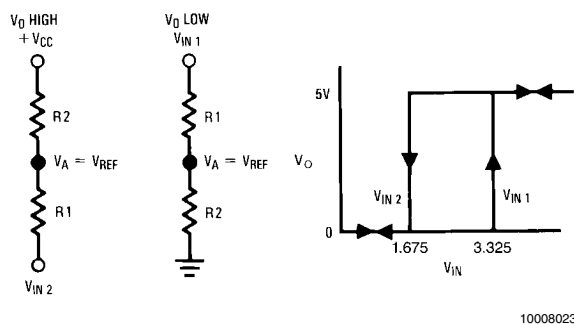


FIGURE 4.

SQUAREWAVE OSCILLATOR

Comparators are ideal for oscillator applications. This square wave generator uses the minimum number of components. The output frequency is set by the RC time constant of the capacitor C_1 and the resistor in the negative feedback R_4 . The maximum frequency is limited only by the large signal propagation delay of the comparator in addition to any capacitive loading at the output, which would degrade the output slew rate.

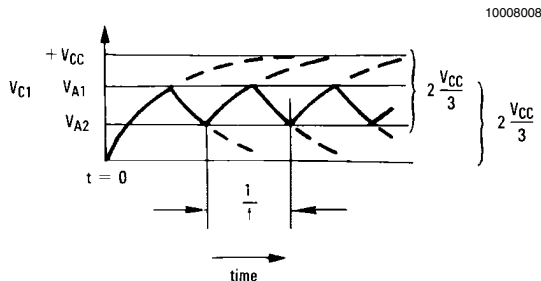
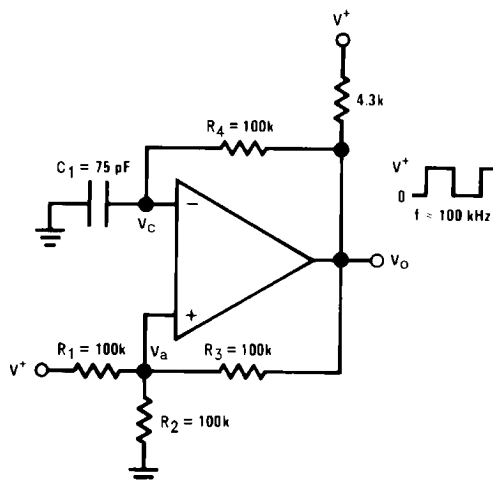


FIGURE 5. Squarewave Oscillator

To analyze the circuit, assume that the output is initially high. For this to be true, the voltage at the inverting input V_c has to be less than the voltage at the non-inverting input V_a . For V_c to be low, the capacitor C_1 has to be discharged and will charge up through the negative feedback resistor R_4 . When it has charged up to value equal to the voltage at the positive input V_{a1} , the comparator output will switch. V_{a1} will be given by:

$$V_{a1} = \frac{V_{CC} R_2}{R_2 + (R_1 // R_2)}$$

If:

$$R_1 = R_2 = R_3$$

Then:

$$V_{a1} = 2V_{CC}/3$$

When the output switches to ground, the value of V_a is reduced by the hysteresis network to a value given by:

$$V_{a2} = V_{CC}/3$$

Capacitor C_1 must now discharge through R_4 towards ground. The output will return to its high state when the voltage across the capacitor has discharged to a value equal to V_{a2} .

For the circuit shown, the period for one cycle of oscillation will be twice the time it takes for a single RC circuit to charge up to one half of its final value. The time to charge the capacitor can be calculated from

$$V_C = V_{max} e^{-\frac{t}{RC}}$$

Where V_{max} is the max applied potential across the capacitor = $(2V_{CC}/3)$

and $V_C = V_{max}/2 = V_{CC}/3$

One period will be given by:

$$1/\text{freq} = 2t$$

or calculating the exponential gives:

$$1/\text{freq} = 2(0.694) R_4 C_1$$

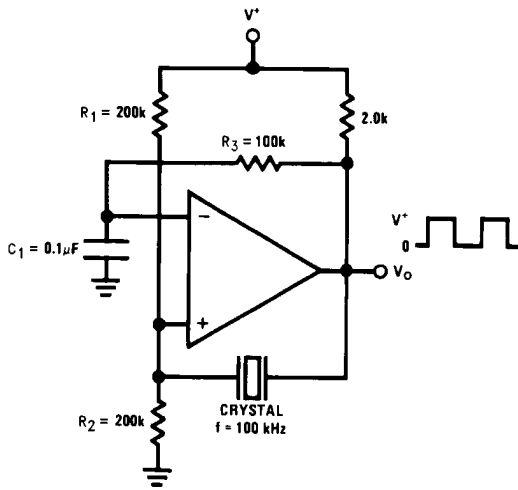
Resistors R_3 and R_4 must be at least two times larger than R_5 to insure that V_O will go all the way up to V_{CC} in the high state. The frequency stability of this circuit should strictly be a function of the external components.

FREE RUNNING MULTIVIBRATOR

A simple yet very stable oscillator that generates a clock for slower digital systems can be obtained by using a resonator as the feedback element. It is similar to the free running multivibrator, except that the positive feedback is obtained through a quartz crystal. The circuit oscillates when the transmission through the crystal is at a maximum, so the crystal in its series-resonant mode.

The value of R_1 and R_2 are equal so that the comparator will switch symmetrically about $+V_{CC}/2$. The RC constant of R_3 and C_1 is set to be several times greater than the period of the oscillating frequency, insuring a 50% duty cycle by maintaining a DC voltage at the inverting input equal to the absolute average of the output waveform.

When specifying the crystal, be sure to order series resonant with the desired temperature coefficient



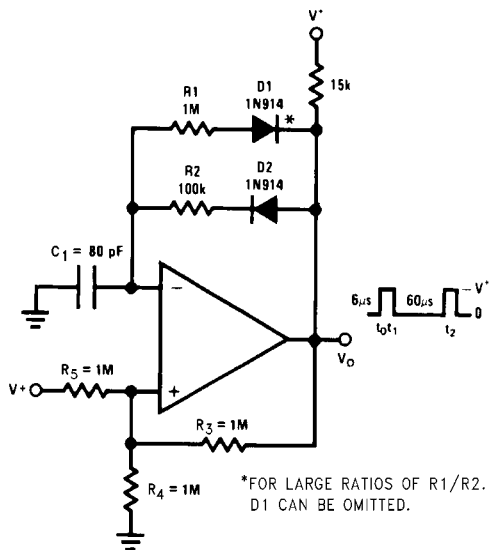
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FIGURE 6. Crystal controlled Oscillator

PULSE GENERATOR WITH VARIABLE DUTY CYCLE

The pulse generator with variable duty cycle is just a minor modification of the basic square wave generator. Providing a separate charge and discharge path for capacitor C_1 generates a variable duty cycle. One path, through R_2 and D_2 will charge the capacitor and set the pulse width (t_1). The other path, R_1 and D_1 will discharge the capacitor and set the time between pulses (t_2).

By varying resistor R_1 , the time between pulses of the generator can be changed without changing the pulse width. Similarly, by varying R_2 , the pulse width will be altered without affecting the time between pulses. Both controls will change the frequency of the generator. The pulse width and time between pulses can be found from:



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FIGURE 7. Pulse Generator

$$V_1 = V_{\max} (1 - e^{-t_1/R_4 C_1}) \quad \text{rise time}$$

$$V_1 = V_{\max} e^{-t_2/R_5 C_1} \quad \text{fall time}$$

Where

$$V_{\max} = \frac{2 V_{CC}}{3}$$

and

$$V_1 = \frac{V_{\max}}{3} = \frac{V_{CC}}{3}$$

Which gives

$$\frac{1}{2} = e^{-t_1/R_4 C_1}$$

t_2 is then given by:

$$\frac{1}{2} = e^{-t_2/R_5 C_1}$$

Solving these equations for t_1 and t_2

$$t_1 = R_4 C_1 \ln 2$$

$$t_2 = R_5 C_1 \ln 2$$

These terms will have a slight error due to the fact that $V_{\max}$ is not exactly equal to $2/3 V_{CC}$ but is actually reduced by the diode drop to:

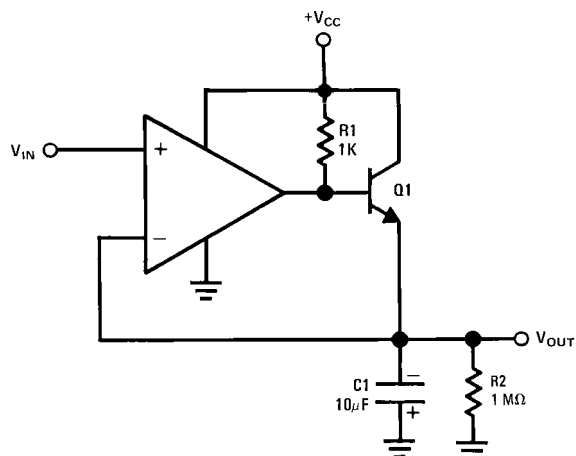
$$V_{\max} = \frac{2}{3} (V_{CC} - V_{BE})$$

$$\frac{1}{2(1 - V_{BE})} = e^{-t_1/R_4 C_1}$$

$$\frac{1}{2(1 - V_{BE})} = e^{-t_2/R_5 C_1}$$

POSITIVE PEAK DETECTOR

Positive peak detector is basically the comparator operated as a unit gain follower with a large holding capacitor from the output to ground. Additional transistor is added to the output to provide a low impedance current source. When the output of the comparator goes high, current is passed through the transistor to charge up the capacitor. The only discharge path will be the $1 M\Omega$ resistor shunting C_1 and any load that is connected to the output. The decay time can be altered simply by changing the $1 M\Omega$ resistor. The output should be used through a high impedance follower to avoid loading the output of the peak detector.

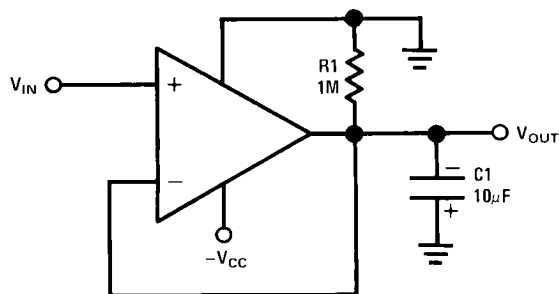


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FIGURE 8. Positive Peak Detector

NEGATIVE PEAK DETECTOR

For the negative detector, the output transistor of the comparator acts as a low impedance current sink. The only discharge path will be the 1 MΩ resistor and any load impedance used. Decay time is changed by varying the 1 MΩ resistor

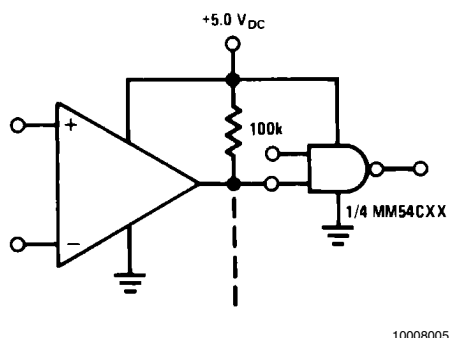


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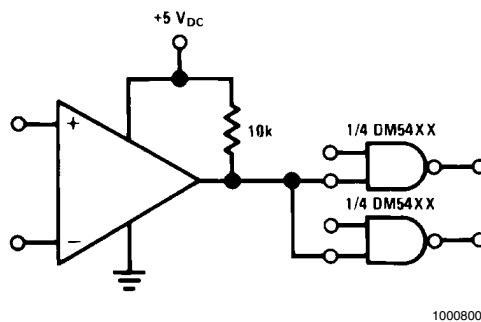
FIGURE 9. Negative Peak Detector

DRIVING CMOS AND TTL

The comparator's output is capable of driving CMOS and TTL Logic circuits.



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FIGURE 10. Driving CMOS


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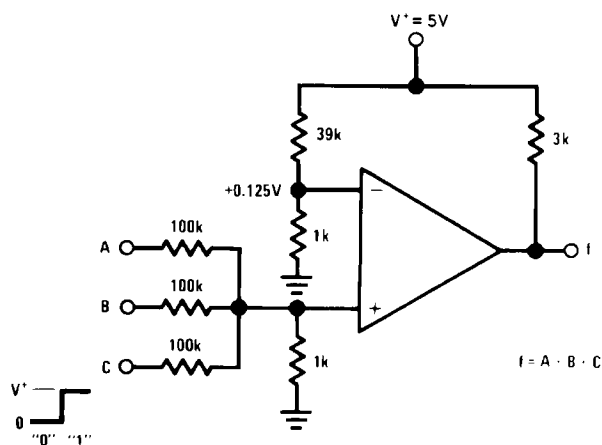
FIGURE 11. Driving TTL

AND GATES

The comparator can be used as three input AND gate. The operation of the gate is as follow:

The resistor divider at the inverting input establishes a reference voltage at that node. The non-inverting input is the sum of the voltages at the inputs divided by the voltage dividers. The output will go high only when all three inputs are high, causing the voltage at the non-inverting input to go above that at inverting input. The circuit values shown work for a "0" equal to ground and a "1" equal to 5V.

The resistor values can be altered if different logic levels are desired. If more inputs are required, diodes are recommended to improve the voltage margin when all but one of the inputs are high.



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FIGURE 12. AND Gate

OR GATES

A three input OR gate is achieved from the basic AND gate simply by increasing the resistor value connected from the inverting input to V_{CC} , thereby reducing the reference voltage. A logic "1" at any of the inputs will produce a logic "1" at the output.

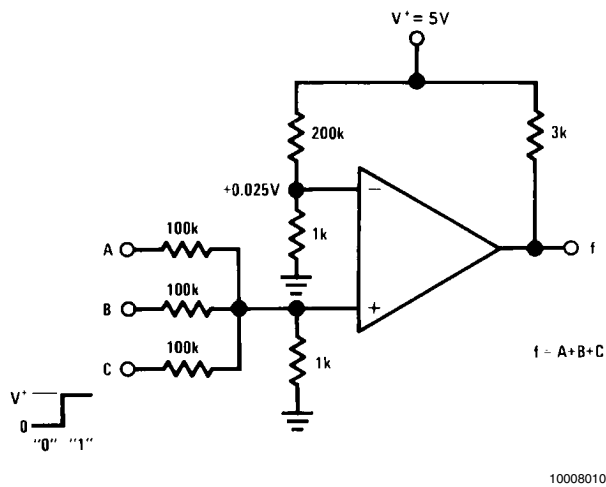


FIGURE 13. OR Gate

ORing THE OUTPUT

By the inherit nature of an open collector comparator, the outputs of several comparators can be tied together with a pull up resistor to V_{CC} . If one or more of the comparators outputs goes low, the output V_O will go low.

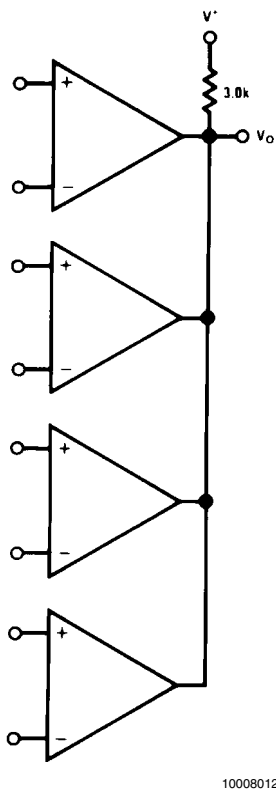


FIGURE 14. ORing the Outputs

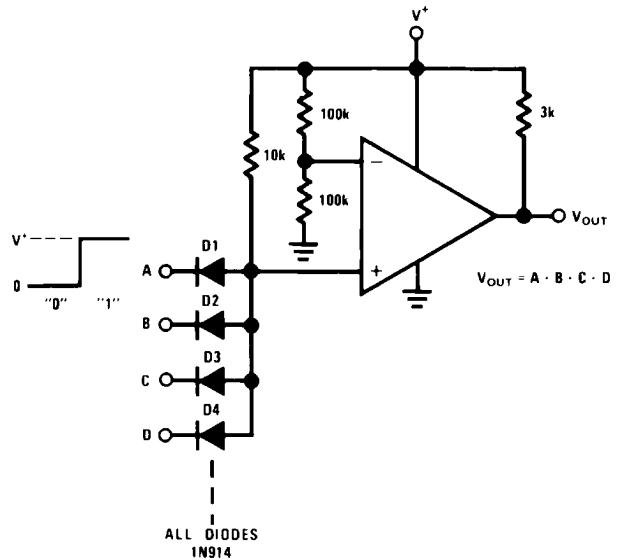
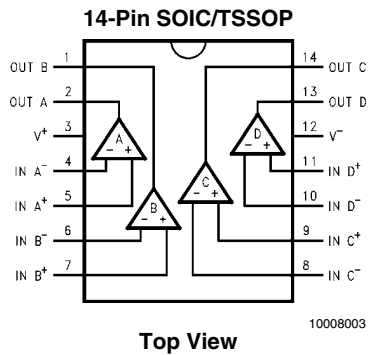
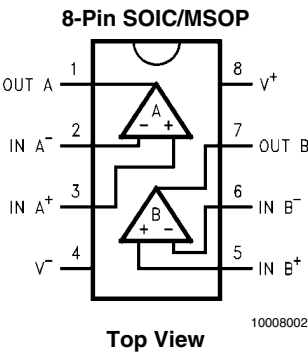
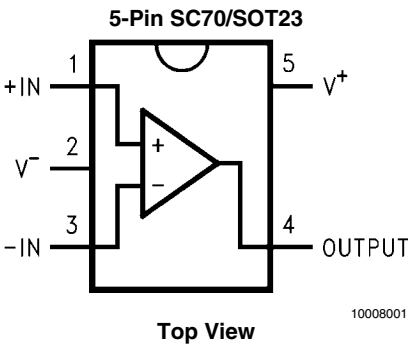


FIGURE 15. Large Fan-In AND Gate

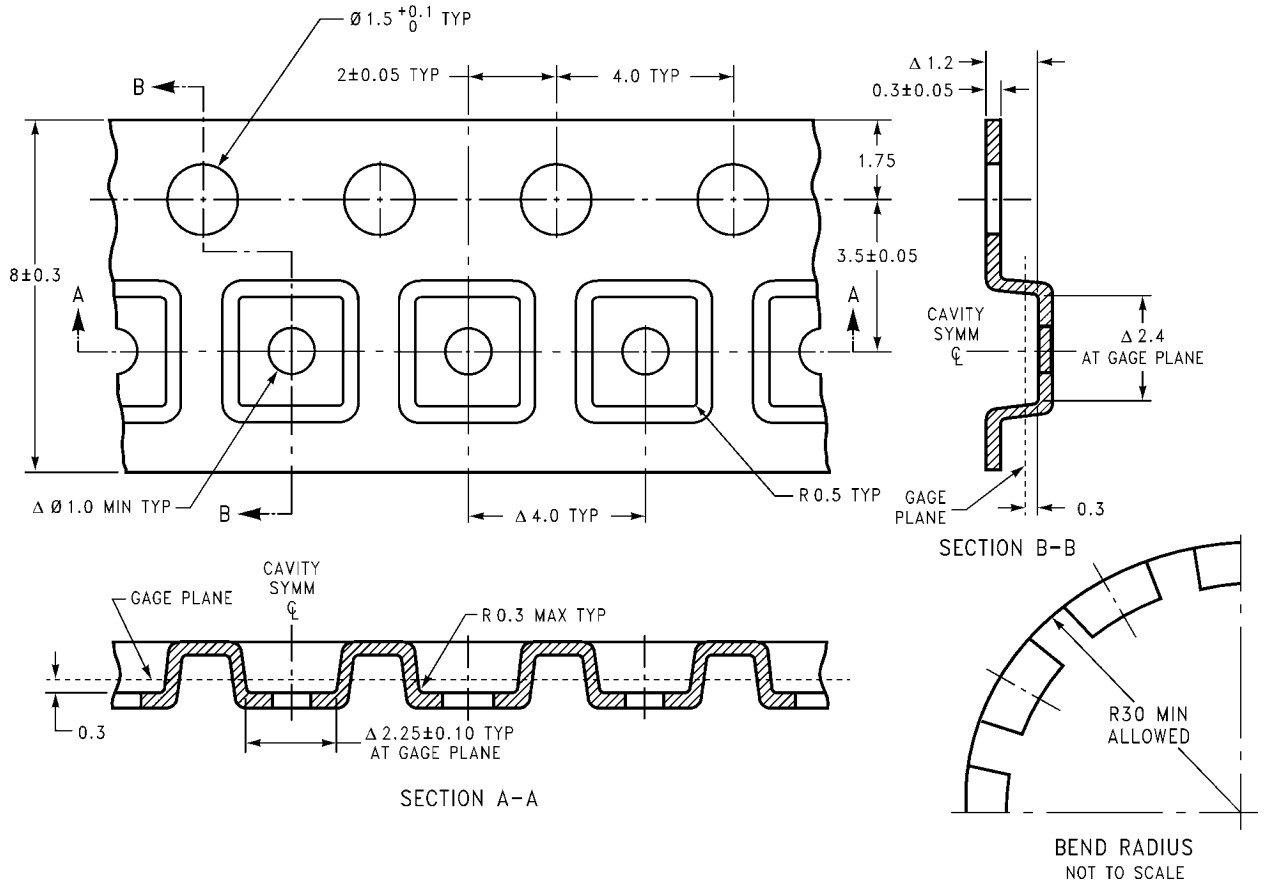
Connection Diagrams



Ordering Information

Package	Temperature Range	Packaging Marking	Transport Media	NSC Drawing
	Industrial -40°C to +85°C			
5-Pin SC70	LMV331M7	C13	1k Units Tape and Reel	MAA05A
	LMV331M7X	C13	3k Units Tape and Reel	
5-Pin SOT23	LMV331M5	C12	1k Units Tape and Reel	MF05A
	LMV331M5X	C12	3k Units Tape and Reel	
8-Pin SOIC	LMV393M	LMV393M	Rails	M08A
	LMV393MX	LMV393M	2.5k Units Tape and Reel	
8-Pin MSOP	LMV393MM	V393	1k Units Tape and Reel	MUA08A
	LMV393MMX	V393	3.5k Units Tape and Reel	
14-Pin SOIC	LMV339M	LMV339M	Rails	M14A
	LMV339MX	LMV339M	2.5k Units Tape and Reel	
14-Pin TSSOP	LMV339MT	LMV339MT	Rails	MTC14
	LMV339MTX	LMV339MT	2.5k Units Tape and Reel	

SC70-5 Tape and Reel Specification



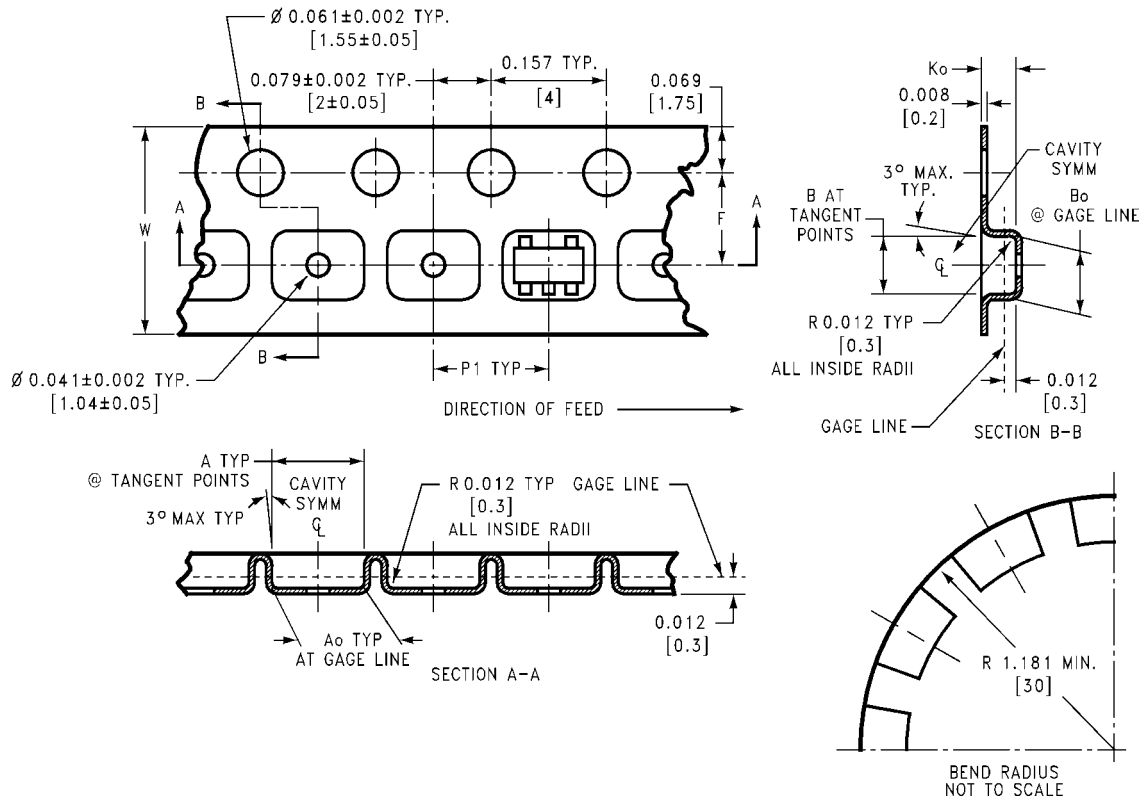
10008044

SOT-23-5 Tape and Reel Specification

TAPE FORMAT

Tape Section	# Cavities	Cavity Status	Cover Tape Status
Leader (Start End)	0 (min)	Empty	Sealed
	75 (min)	Empty	Sealed
Carrier	3000	Filled	Sealed
	250	Filled	Sealed
Trailer (Hub End)	125 (min)	Empty	Sealed
	0 (min)	Empty	Sealed

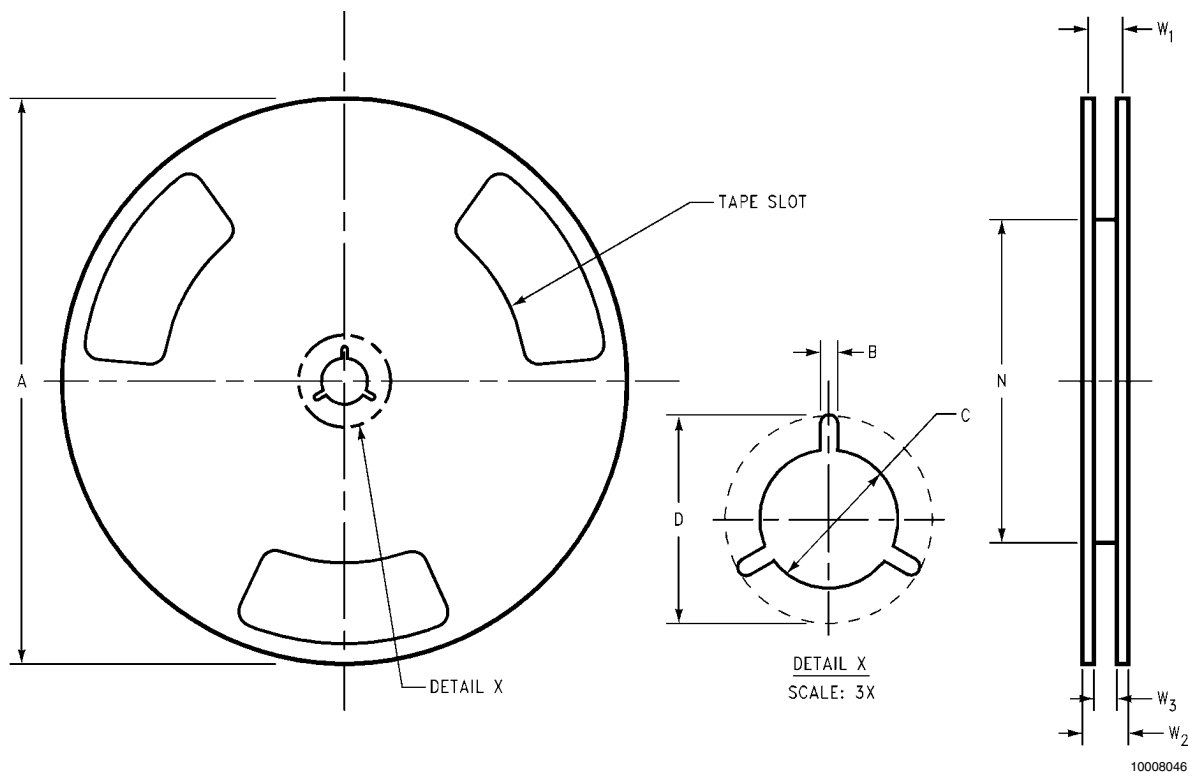
TAPE DIMENSIONS



10008045

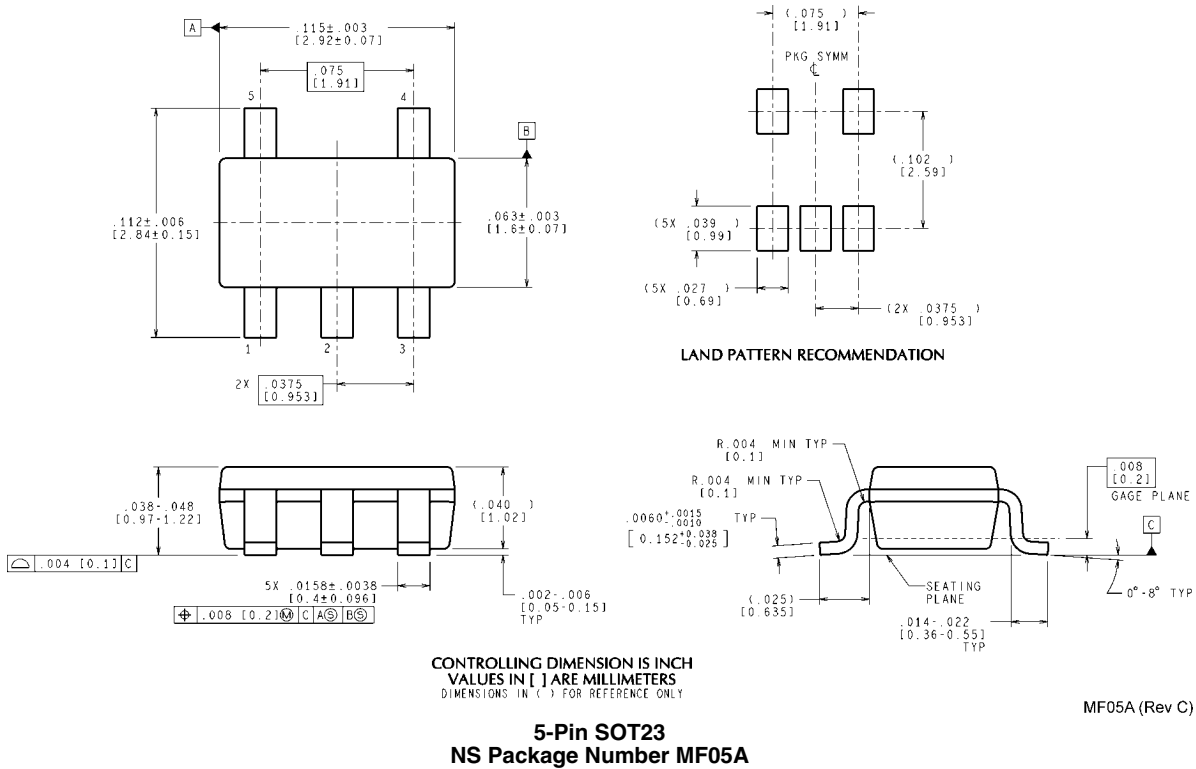
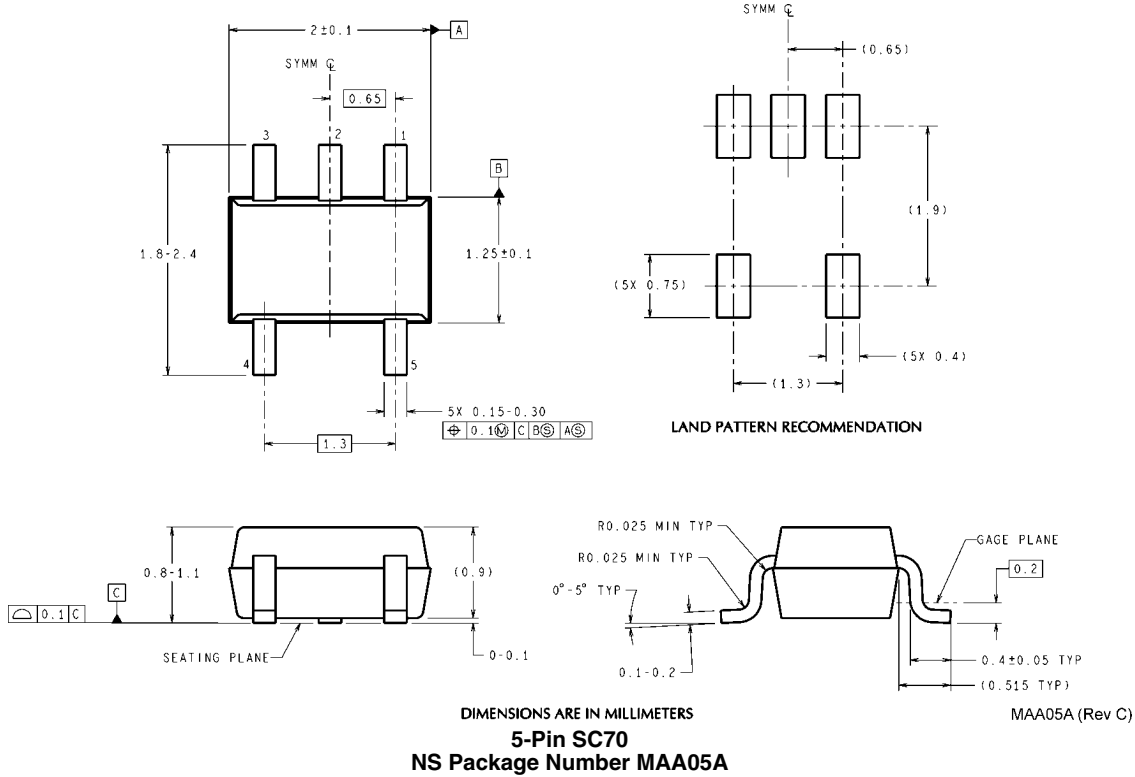
8 mm	0.130 (3.3)	0.124 (3.15)	0.130 (3.3)	0.126 (3.2)	0.138 $\pm$ 0.002 (3.5 $\pm$ 0.05)	0.055 $\pm$ 0.004 (1.4 $\pm$ 0.11)	0.157 (4)	0.315 $\pm$ 0.012 (8 $\pm$ 0.3)
Tape Size	DIM A	DIM Ao	DIM B	DIM Bo	DIM F	DIM Ko	DIM P1	DIM W

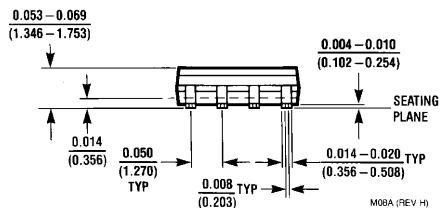
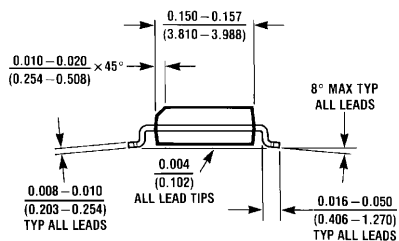
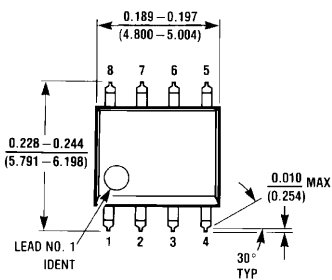
REEL DIMENSIONS



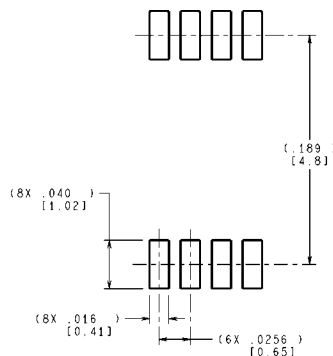
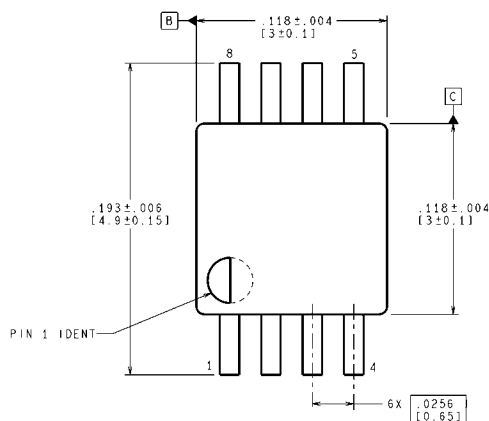
8 mm	7.00	0.059	0.512	0.795	2.165	$0.331 + 0.059/-0.000$	0.567	$W1 + 0.078/-0.039$
	330.00	1.50	13.00	20.20	55.00	$8.40 + 1.50/-0.00$	14.40	$W1 + 2.00/-1.00$
Tape Size	A	B	C	D	N	W1	W2	W3

Physical Dimensions inches (millimeters) unless otherwise noted

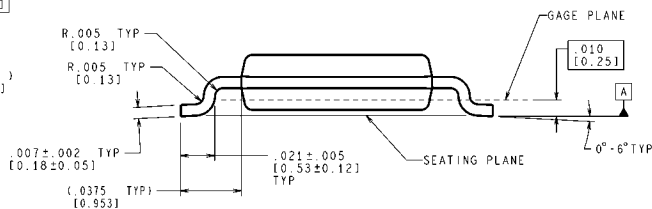
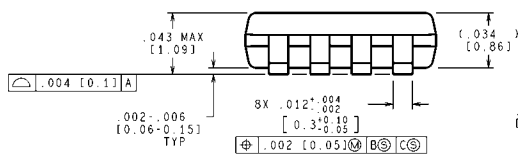




8-Pin SOIC
NS Package Number M08A



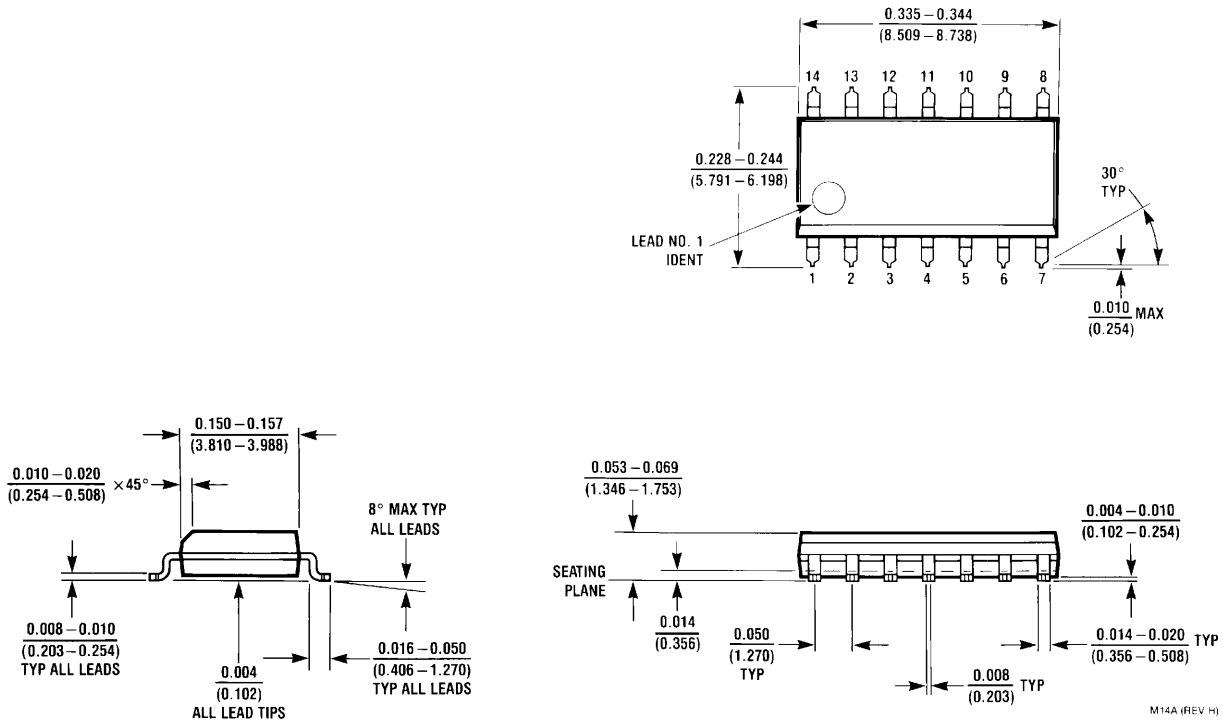
LAND PATTERN RECOMMENDATION



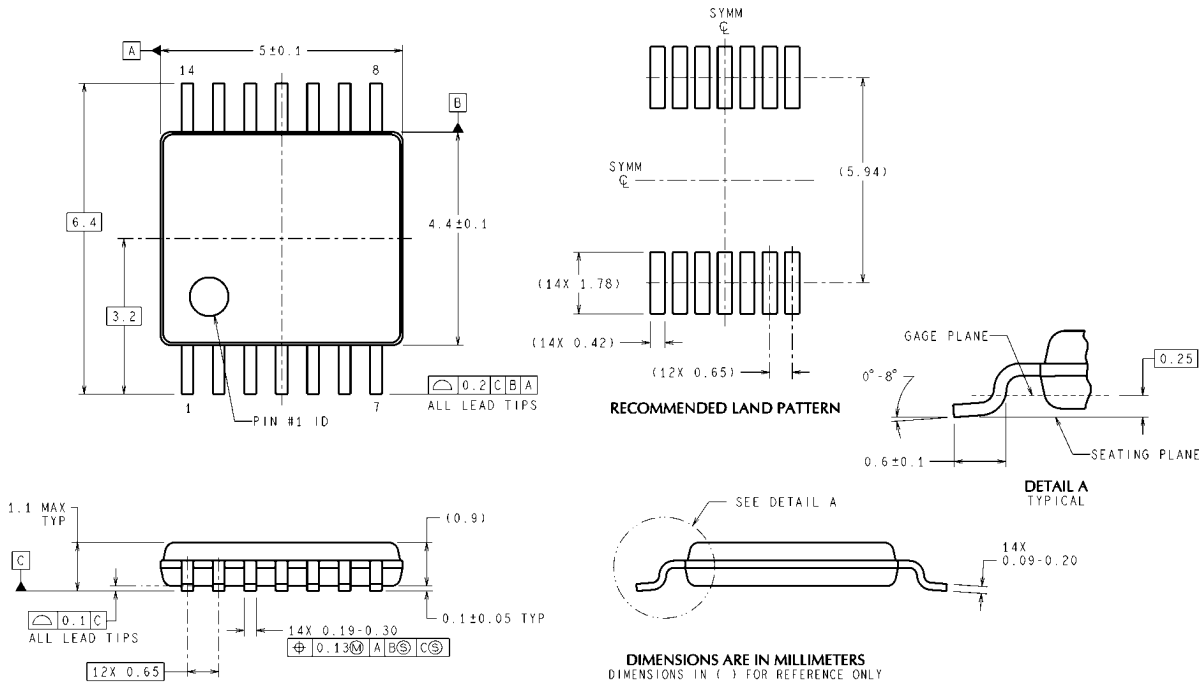
CONTROLLING DIMENSION IS INCH
VALUES IN [] ARE MILLIMETERS

8-Pin MSOP
NS Package Number MUA08A

MUA08A (Rev E)



14-Pin SOIC
NS Package Number M14A



14-Pin TSSOP
NS Package Number MTC14

MTC14 (Rev D)

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